

| L Number | Hits | Search Text | DB | Time stamp |
|----------|---------|--|---|---------------------|
| 1 | 1349463 | sensor\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 12:57 |
| 2 | 1895 | sensor\$3 and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:39 |
| 3 | 440 | (sensor\$3 and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))) and ((nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo) near5 (oxid\$8 or nitri\$8)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:40 |
| 4 | 389 | ((sensor\$3 and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))) and ((nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo) near5 (oxid\$8 or nitri\$8))) and (bond\$5 or connect\$5) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:40 |
| 5 | 148663 | (acceleration or pressure) near3 sensor\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:47 |
| 6 | 215 | ((acceleration or pressure) near3 sensor\$3) and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:48 |
| 7 | 52 | ((acceleration or pressure) near3 sensor\$3) and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))) and ((nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo) near5 (oxid\$8 or nitri\$8)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:40 |
| 8 | 47 | ((((acceleration or pressure) near3 sensor\$3) and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo))) and ((nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo) near5 (oxid\$8 or nitri\$8))) and (bond\$5 or connect\$5) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:47 |
| 9 | 6580 | ((acceleration or pressure) near3 sensor\$3) and ((semiconductor or silicon) near5 substrate) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:47 |
| 10 | 78 | ((acceleration or pressure) near3 sensor\$3) and ((semiconductor or silicon) near5 substrate)) and ((electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10) near5 (nickel or ni or tantalum or ta or tungsten or w or molybdenum or mo)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/05/21 13:48 |